· Low forward voltage drop, low power losses

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- 10 s per JESD 22-B106
- AEC-Q101 gualified available - Automotive ordering code: base P/NHM3
- please see www.vishay.com/doc?99912

NS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and

ng d

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER		SYMBOL	VX20202C	UNIT					
Maximum repetitive peak reverse voltage		V _{RRM}	V _{RRM} 200						
Maximum average forward rectified current	per device		20	٨					
(fig. 1)	per diode	IF(AV)	10	— A					
Peak forward surge current 8.3 ms single half superimposed on rated load	sine-wave	I _{FSM}	150	А					
Operating junction temperature range		T _J ⁽¹⁾	-40 to +175						
Storage temperature range		T _{STG}	-40 to +175	U U					

Note

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{0,JA}$

Dual High Voltage TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.58$ V at $I_F = 5.0$ A

FEATURES

- Trench MOS Schottky technology
- · High efficiency operation
- Solder bath temperature 275 °C maximum,
- - Material categorization: for definitions of compliance

TYPICAL	APPLICATION

automotive application.

MECHANICAL DATA

Case: TO-220AB
Molding compound meets UL 94 V-0 flammability ratin
Base P/N-M3 - halogen-free, RoHS-compliant
Base P/NHM3_X - halogen-free, RoHS-compliant, and
AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102 M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Mounting torque: 10 in-lbs maximum

TO-220AB PIN 1 O PIN 2 CASE

PRIMARY CHARACTERISTICS							
I _{F(AV)}	2 x 10 A						
V _{RRM}	200 V						
I _{FSM}	150 A						
V_F at I_F = 10 A (T_J = 125 °C)	0.65 V						
T _J max.	175 °C						
Package	TO-220AB						
Circuit configuration	Common cathode						







COMPLIANT

HALOGEN

FREE







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ELECTRICAL CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	TEST CO	NDITIONS	SYMBOL	TYP.	MAX.	UNIT			
	I _F = 2.5 A		V _F ⁽¹⁾	0.68	-				
	I _F = 5 A	T _J = 25 °C		0.73	-	V			
Instantaneous forward valtage per diade	I _F = 10 A			0.79	0.84				
Instantaneous forward voltage per diode	I _F = 2.5 A			0.52	-				
	$I_F = 5 A$	T _J = 125 °C		0.58	-				
	I _F = 10 A			0.65	0.70				
	V _B = 160 V	T _J = 25 °C		0.0006	-				
Reverse current at rated V_R per diode	$v_{\rm R} = 100 v$	T _J = 125 °C		0.9	-	mA			
	V 200 V	T _J = 25 °C	'R (=/	-	0.05	ШA			
	V _R = 200 V	T _J = 125 °C		2.2	8				
Typical junction capacitance	4.0 V, 1 MHz		CJ	650	-	pF			

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER SYMBOL VX20202C UNIT							
Typical thermal resistance per device	R _{θJC} ⁽¹⁾	1	°C/W				

Note

⁽¹⁾ Thermal resistance junction-to-case to follow JEDEC[®] 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)									
PREFERRED P/N UNIT WEIGHT (g) PACKAGE CODE BASE QUANTITY DELIVERY MODE									
VX20202C-M3/P	2.03	Р	50/tube	Tube					
VX20202CHM3_A/P (1)	2.03	Р	50/tube	Tube					

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

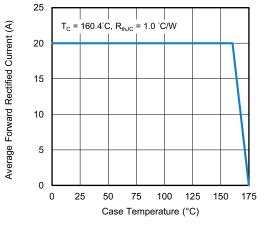


Fig. 1 - Maximum Forward Current Derating Curve

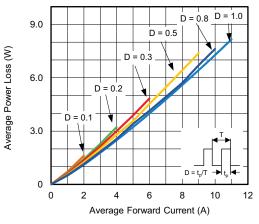


Fig. 2 - Average Power Loss Characteristics

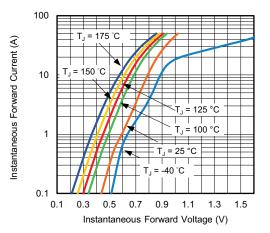


Fig. 3 - Typical Instantaneous Forward Characteristics

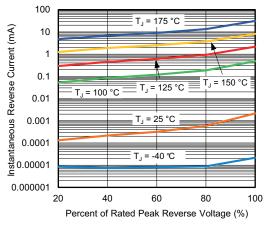


Fig. 4 - Typical Reverse Leakage Characteristics

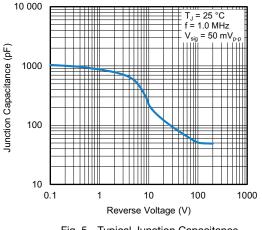


Fig. 5 - Typical Junction Capacitance

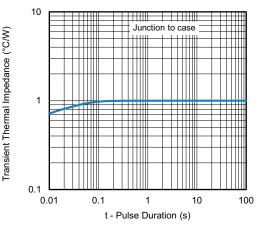


Fig. 6 - Typical Transient Thermal Impedance

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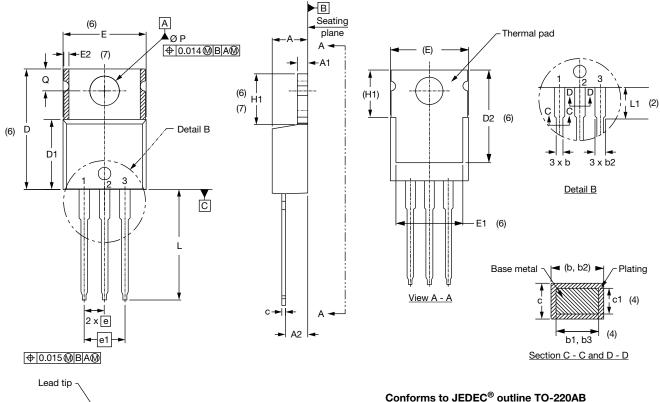
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VX20202C

Vishay General Semiconductor



DIMENSIONS in millimeters (inches) TO-220AB



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Conforms to JEDEC[®] outline TO-220AB

SYMBOL	MILLIMETERS		INCHES		NOTES		OVMDOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	NOTES		SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.25	4.65	0.167	0.183			D2	11.68	12.88	0.460	0.507	6
A1	1.14	1.40	0.045	0.055			E	10.11	10.51	0.398	0.414	3, 6
A2	2.56	2.92	0.101	0.115			E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040			E2	-	0.76	-	0.030	7
b1	0.38	0.97	0.015	0.038	4		е	2.41	2.67	0.095	0.105	
b2	1.20	1.73	0.047	0.068			e1	4.88	5.28	0.192	0.208	
b3	1.14	1.73	0.045	0.068	4		H1	5.84	6.86	0.230	0.270	6, 7
С	0.36	0.61	0.014	0.024			L	13.52	14.02	0.532	0.552	
c1	0.36	0.56	0.014	0.022	4		L1	3.32	3.82	0.131	0.150	2
D	14.85	15.25	0.585	0.600	3		ØР	3.54	3.73	0.139	0.147	
D1	8.38	9.02	0.330	0.355]	Q	2.60	3.00	0.102	0.118	

Notes

 $^{(1)}\,$ Dimensioning and tolerancing as per ASME Y14.5M-1994

⁽²⁾ Lead dimension and finish uncontrolled in L1

(3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁴⁾ Dimension b1, b3 and c1 apply to base metal only

⁽⁵⁾ Controlling dimensions: inches

⁽⁶⁾ Thermal pad contour optional within dimensions E, H1, D2 and E1

 $^{(7)}$ Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed

(8) Outline conforms to JEDEC[®] TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline

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